

Film Capacitors

EMI Suppression Capacitors (MKP)

 Series/Type:
 B32924*4 ... B32926*4

 Date:
 December 2016

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EMI suppression capacitors (MKP)

X2 / 350 V AC

B32924*4 ... B32926*4

Typical applications

- X2 class for interference suppression
- Severe ambient conditions
- "E-meters", "In-series" with mains
- "Across the line" applications

Climatic

- Max. operating temperature: 110 °C
- Climatic category (IEC 60068-1): 40/110/56

Construction

- Dielectric: polypropylene (MKP)
- Plastic case (UL 94 V-0)
- Epoxy resin sealing (UL 94 V-0)

Features

- Internal series construction
- Good self-healing properties
- High current handling
- RoHS-compatible
- Stable capacitance in severe ambient conditions 85 °C, 85% RH, 330 V AC, 1000 h

Terminals

- Parallel wire leads, lead-free tinned
- Special lead lengths available on request

Marking

Manufacturer's logo, lot number, date code, rated capacitance (coded), capacitance tolerance (code letter), rated AC voltage (IEC), series number, sub-class (X2), dielectric code (MKP), climatic category,

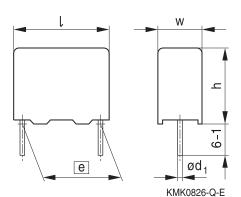
passive flammability category, approvals

Delivery mode

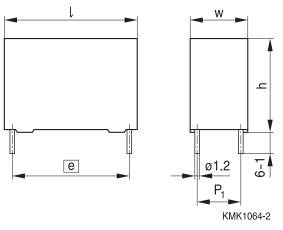
Bulk (untaped) Taped (Ammo pack or reel) For taping details, refer to chapter "Taping and packing".

Dimensional drawing

Drawing 1







P1 = 20.3 mm

Dimensions in mm

Pins	Lead	Lead	Туре	Drawing
	spacing	diameter		
	<i>e</i> ±0.4	$d_1 \pm 0.05$		
2	27.5	0.8	B32924*4	1
4	37.5	1.0	B32926*4	1 / 2 ¹⁾

1) A few individual types only





Marking example (position of marks may vary):



Approvals

Approval marks	Standards	Certificate
3 15	EN 60384-14, IEC 60384-14	ENEC-01393 (approved by UL Demko)
c Al us	UL 60384-14, CSA E60384-14	E97863

Overview of available types

Lead spacing	27.5 mm	37.5 mm
Туре	B32924*4	B32926*4
C _R (μF)		
0.47		
0.56		
0.68		
0.82		
1.0		
1.2		
1.5		
1.8		
2.2		
2.7		
3.3		
4.7		
5.6		
6.8		
8.2		
10		





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Ordering codes and packing units

Lead	C _R	Max. dimensions	Ordering code	Straight	Straight	Pins
spacing		$w \times h \times I$	(composition see	terminals,	terminals,	
			below)	Reel	Untaped	
mm	μF	mm		pcs./MOQ	pcs./MOQ	
27.5	0.47	11.0 × 19.0 × 31.5	B32924A4474+***	1400	1280	2
	0.56	$11.0\times19.0\times31.5$	B32924A4564+***	1400	1280	2
	0.68	$11.0 \times 21.0 \times 31.5$	B32924A4684+***	1400	1280	2
	0.82	$12.5 \times 21.5 \times 31.5$	B32924A4824M***	1200	1120	2
	0.82	$13.5\times23.0\times31.5$	B32924B4824K***	1000	1040	2
	1.0	$13.5\times23.0\times31.5$	B32924A4105M***	1000	1040	2
	1.0	$14.0\times24.5\times31.5$	B32924B4105K***	_	1040	2
	1.2	$14.0\times24.5\times31.5$	B32924A4125M***	_	1040	2
	1.5	$16.0\times32.0\times31.5$	B32924B4155+***	_	880	2
	1.5	$18.0 \times 27.5 \times 31.5$	B32924A4155+***	_	800	2
	1.8	$16.0\times32.0\times31.5$	B32924B4185+***	_	880	2
	1.8	$18.0 \times 27.5 \times 31.5$	B32924A4185M***	_	800	2
	2.2	$18.0\times33.0\times31.5$	B32924S4225+***	_	800	2
	2.2	$19.0\times30.0\times31.5$	B32924A4225M***	_	720	2
	2.2	$21.0 \times 31.0 \times 31.5$	B32924B4225K***	_	720	2
	2.7	$22.0\times 33.0\times 31.5$	B32924A4275+***	_	640	2
	3.3	$22.0\times 36.5\times 31.5$	B32924A4335M***	_	640	2
	3.3	$22.0\times48.0\times31.5$	B32924B4335K***	-	320	2

MOQ = Minimum Order Quantity, consisting of 4 packing units. Further intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

 $M = \pm 20\%$

K = ±10%

*** = Packaging code:

000 = Straight terminals, untaped (lead length 6 - 1 mm)

- $\begin{array}{rl} \text{003} = & \text{Straight terminals, untaped} \\ & (\text{lead length 3.2 } \pm 0.3 \text{ mm}) \end{array}$
- 189 = Straight terminals, Reel



X2/350 V AC

X2

Ordering codes and packing units

Lead	C _R	Max. dimensions	Ordering code	Straight	Straight	Pins
spacing		$w \times h \times I$	(composition see	terminals,	terminals,	
			below)	Reel	Untaped	
mm	μF	mm		pcs./MOQ	pcs./MOQ	
37.5	1.0	12.0 × 22.0 × 42.0	B32926A4105+***	_	1620	2
	1.2	$12.0\times22.0\times42.0$	B32926A4125M***	_	1620	2
	1.2	$14.0\times25.0\times42.0$	B32926B4125K***	_	1380	2
	1.5	$14.0\times25.0\times42.0$	B32926A4155+***	_	1380	2
	1.8	$14.0\times25.0\times42.0$	B32926A4185M***	_	1380	2
	1.8	$16.0\times28.5\times42.0$	B32926B4185K***	_	800	2
	2.2	$16.0\times28.5\times42.0$	B32926A4225+***	_	800	2
	2.7	$17.5\times32.0\times42.0$	B32926A4275M***	_	760	2
	2.7	$18.0\times32.5\times42.0$	B32926B4275K***	_	720	2
	3.3	$18.0\times32.5\times42.0$	B32926A4335M***	_	720	2
	3.3	$20.0\times39.5\times42.0$	B32926B4335K***	_	640	2
	4.7	$20.0\times39.5\times42.0$	B32926B4475M***	_	640	2
	4.7	$28.0\times37.0\times42.0$	B32926A4475K***	—	440	2
	5.6	$28.0\times37.0\times42.0$	B32926A4565M***	_	440	2
	5.6	$28.0\times42.5\times42.0$	B32926B4565K***	_	440	2
	6.8	$28.0\times42.5\times42.0$	B32926A4685+***	_	440	2
	8.2	$30.0\times45.0\times42.0$	B32926A4825M***	-	400	2
	8.2	33.0 imes 48.0 imes 42.0	B32926B4825K***	-	180	4
	10.0	33.0 imes 48.0 imes 42.0	B32926A4106M***	-	180	4

MOQ = Minimum Order Quantity, consisting of 4 packing units. Further intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

M =±20% K = ±10% *** = Packaging code:

000 = Straight terminals, untaped (lead length 6 - 1 mm)

- $\begin{array}{ll} 003 = & {\rm Straight\ terminals,\ untaped} \\ & ({\rm lead\ length\ 3.2\ \pm 0.3\ mm}) \end{array}$
- 189 = Straight terminals, Reel





X2/350 V AC

Technical data

Reference standard: IEC / UL 60384-14. All data given at T = 20 $^{\circ}$ C unless otherwise specified.

	t			
Rated AC voltage (IEC 60384-14)	350 V (50/60 Hz)			
Maximum continuous DC voltage V_{DC}	650 V DC			
Max. operating temperature T _{op,max}	+110 °C			
DC test voltage	$4.3 \cdot 350 = 7$	1505 V DC, 2 s		
The repetition of this DC voltage test m	ay damage th	ne capacitor. Special ca	re must be taken in	
case of use several capacitors in a par				
Dissipation factor tan δ (in 10 ⁻³)		C _R ≤ 4.7 μF	C _R > 4.7 μF	
at 20 °C (upper limit values)	at 1 kHz	0.9	1.2	
Insulation resistance R_{ins} or time constant $\tau = C_R \cdot R_{ins}$ at 100 V DC, 20 °C, rel. humidity \leq 65% and for 60 s (minimum as-delivered values)	30 000 s			
Passive flammability category	В			
Capacitance tolerances (measured at 1 kHz)	±10% (K), ±2	20% (M)		
Damp heat test	Test conditio	ons		
	Temperature Relative hun Test duration Voltage valu	nidity: n:	+85 °C ±2 °C 85% ±2% 1000 hours 330 V AC, 50 Hz	
Limit values after damp heat test	Capacitance change (Δ C/C): Dissipation factor change Δ tan δ : Insulation resistance R _{ins} :		\leq 7.5% \leq 3 · 10 ⁻³ (at 1 kHz) 50% of initial limit	



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Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in $V/\mu s$.

" k_0 " represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V²/µs.

Note:

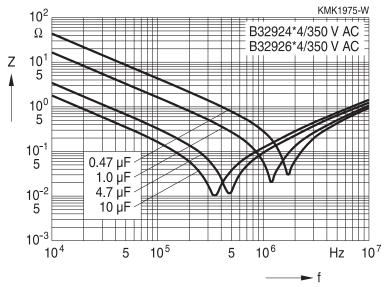
The values of dV/dt and k_0 provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt and k₀ values

Lead spacing	27.5 mm	37.5 mm
dV/dt in V/µs	80	40
k₀in V²/µs	27 400	10 400

Impedance Z versus frequency f

(typical values)

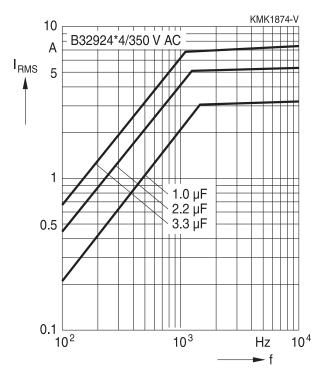




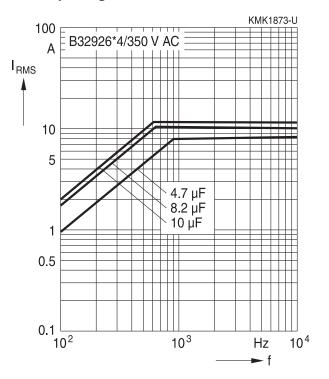


Permissible AC current I_{RMS} versus frequency f (for sinusoidal waveform, TA \leq 90 °C and Δ ESR < 100% from receipt condition)

Lead spacing 27.5 mm



Lead spacing 37.5 mm





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X2

Testing and Standards

Test	Reference	Conditions of test		Performance requirements
Voltage proof	IEC 60384-14	Voltage proof between terminals, 4.3 V_R , 2 s Terminals and enclosure: 2 V_R + 1500 V AC Insulation resistance, R_{INS} Capacitance, C Dissipation factor, tan δ		Within specified limits
Robustness of terminations	IEC 60068-2-21			Capacitance and tan δ within specified limits
Resistance to soldering heat	IEC 60068-2-20, test Tb, method 1A	Solder bath tempera 260 ± 5 °C, immersion 10 seconds		$\Delta C/C_0 \le 5\%$ tan δ within specified limits
Vibration	IEC 60384-14	Test F _c : vibration sinusoidal Displacement: 0.75 mm Accleration: 98 m/s ² Frequency: 10 Hz 500 Hz Test duration: 3 orthogonal axes, 2 hours each axe		No visible damage
Bump	IEC 60384-14	Test Eb: Total 4000 bumps with 400 m/s ² mounted on PCB 6 ms duration		No visible damage $ \Delta C/C_0 \le 5\%$ tan δ within specified limits
Damp heat steady state	IEC 60384-14	Test Ca 40 °C / 93% RH / 56 days		No visible damage $\begin{split} & \Delta C/C_0 \leq 5\% \\ & \Delta \ tan \ \delta l \leq 0.008 \ for \ C \leq 1 \ \mu F \\ & \Delta \ tan \ \delta l \leq 0.005 \ for \ C > 1 \ \mu F \\ &Voltage \ proof \\ &R_{\text{INS}} \geq 50\% \ of \ initial \ limit \end{split}$
Special biased damp heat test	-	85 °C/85% relative humidity/1000 h /330 V AC, 50 Hz		$\begin{split} & \Delta C/C_0 \leq 7.5\% \\ & \Delta \tan \delta \leq 0.003 \\ &R_{\text{INS}} \geq 50\% \text{ of initial limit} \end{split}$
Rapid change of temperature	IEC 60384-14	T_A = lower category temperature T_B = upper category temperature 5 cycles, duration t = 30 min.		No visible damage $ \Delta C/C_0 \le 5\%$ tan δ within specified limits





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Test	Reference	Conditions of test	Performance requirements
Climatic sequence	IEC 60384-14	Dry heat $-T_B / 16$ h. Damp heat cyclic, 1st cycle + 55 °C / 24h / 95% 100% RH Cold $-T_A / 2h$ Damp heat cyclic, 5 cycles + 55 °C / 24h / 95% 100% rh	No visible damage $ \Delta C/C_0 \le 5\%$ $ \Delta \tan \delta \le 0.008$ for $C \le 1 \mu F$ $ \Delta \tan \delta \le 0.005$ for $C > 1 \mu F$ Voltage proof $R_{INS} \ge 50\%$ of initial limit
Impulse test endurance	IEC 60384-14	3 impulses $T_B / 1.25 V_R / 1000$ hours, 1000 V_{RMS} for 0.1 s every hour	No visible damage $ \Delta C/C_0 \le 10\%$ $ \Delta \tan \delta \le 0.008$ for $C \le 1 \mu F$ $ \Delta \tan \delta \le 0.005$ for $C > 1 \mu F$ Voltage proof $R_{INS} \ge 50\%$ of initial limit
Passive flammability	IEC 60384-14	Flame applied for a period of time depending on capacitor volume	В
Active flammability	IEC 60384-14	20 discharges at 2.5 kV + V _R	The cheesecloth shall not burn with a flame

Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/ -0.5 mm from capacitor body or seating plane
Evaluation criteria:	
Visual inspection	Wetting of wire surface by new solder \geq 90%, free-flowing solder



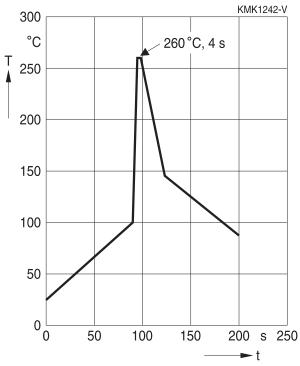
X2/350 V AC



1.2 Resistance to soldering heat

Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A. Conditions:

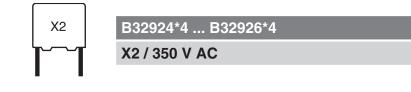
Serie	S	Solder bath temperature	Soldering time
MKT	boxed (except $2.5 \times 6.5 \times 7.2$ mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP MKP	(lead spacing > 7.5 mm)		
MKT	boxed (case $2.5 \times 6.5 \times 7.2$ mm)	-	5 ±1 s
MKP MKT	(lead spacing \leq 7.5 mm) uncoated (lead spacing \leq 10 mm) insulated (B32559)		< 4 s recommended soldering profile for MKT uncoated (lead spacing \leq 10 mm) and insulated (B32559)



Immersion depth	2.0 +0/ -0.5 mm from capacitor body or seating plane	
ShieldHeat-absorbing board, (1.5 ±0.5) mm thick, betweebody and liquid solder		
Evaluation criteria:		
Visual inspection	No visible damage	
ΔC/C ₀ 2% for MKT/MKP/MFP 5% for EMI suppression capacitors		
tan δ	As specified in sectional specification	

Please read *Cautions and warnings* and *Important potes* at the end of this document. Downloaded from <u>Arrow.com</u>.





1.3 General notes on soldering

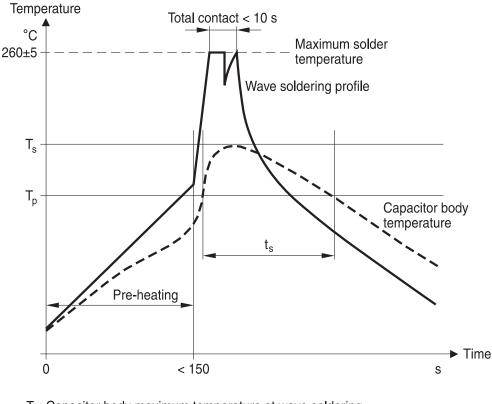
Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
 - diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommendations

As a reference, the recommended wave soldering profile for our film capacitors is as follows:

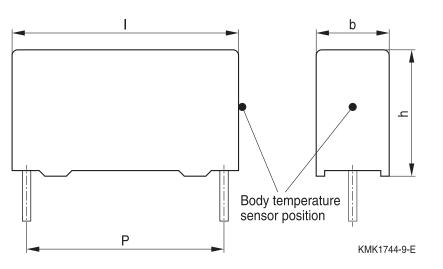


 T_s : Capacitor body maximum temperature at wave soldering T_p : Capacitor body maximum temperature at pre-heating

KMK1745-A-E







Body temperature should follow the description below:

- MKP capacitor During pre-heating: T_p ≤ 110 °C During soldering: T_s ≤ 120 °C, t_s ≤ 45 s
- MKT capacitor During pre-heating: $T_p \le 125 \text{ °C}$ During soldering: $T_s \le 160 \text{ °C}$, $t_s \le 45 \text{ s}$

When SMD components are used together with leaded ones, the film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.

Leaded film capacitors are not suitable for reflow soldering.

In order to ensure proper conditions for manual or selective soldering, the body temperature of the capacitor (T_s) must be \leq 120 °C.

One recommended condition for manual soldering is that the tip of the soldering iron should be < $360 \degree$ C and the soldering contact time should be no longer than 3 seconds.

For uncoated MKT capacitors with lead spacings \leq 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering

Please refer to EPCOS Film Capacitor Data Book in case more details are needed.





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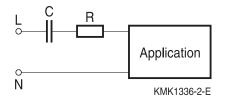
Application note for the different possible X1 / X2 positions

In series with the powerline (i.e. capacitive power supply)

Typical Applications:

- Power meters
- ECUs for white goods and household appliances
- Different sensor applications
- Severe ambient conditions

Basic circuit



Required features

- High capacitance stability over the lifetime
- Narrow tolerances for a controlled current supply

Recommended EPCOS product series

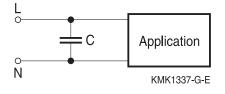
- B3293* (305 V AC) heavy duty with EN approval for X2 (UL Q1/2010)
- B3265* MKP series standard MKP capacitor without safety approvals
- B3267*L MKP series standard MKP capacitor without safety approvals
- B3292*H/J (305 V AC), severe ambient condition, approved as X2

In parallel with the powerline

Typical Applications:

Standard X2 are used parallel over the mains for reducing electromagnetic interferences coming from the grid. For such purposes they must meet the applicable EMC directives and standards.

Basic circuit



Required features

- Standard safety approvals (ENEC, UL, CSA, CQC)
- High pulse load capability
- Withstand surge voltages

Recommended EPCOS product series

- B3292*C/D (305 V AC) standard series, approved as X2
- B3291* (330 V AC), approved as X1
- B3291* (530 V AC), approved as X1
- B3292*H/J (305 V AC), severe ambient condition, approved as X2



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Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Торіс	Safety information	Reference chapter "General technical
		information"
Storage	Make sure that capacitors are stored within the specified	4.5
conditions	range of time, temperature and humidity conditions.	"Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive	5.3
	flammability), avoid overload of the capacitors (active	"Flammability"
	flammability) and consider the flammability of materials.	
Resistance to	Do not exceed the tested ability to withstand vibration.	5.2
vibration	The capacitors are tested to IEC 60068-2-6.	"Resistance to
	EPCOS offers film capacitors specially designed for	vibration"
	operation under more severe vibration regimes such as	
	those found in automotive applications. Consult our	
	catalog "Film Capacitors for Automotive Electronics".	

Торіс	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of	When embedding finished circuit assemblies in plastic	3 "Embedding of
capacitors in	resins, chemical and thermal influences must be taken	capacitors in finished
finished	into account.	assemblies"
assemblies	Caution: Consult us first, if you also wish to embed other	
	uncoated component types!	





Design of EMI Capacitors

EPCOS EMI capacitors use polypropylene (PP) film metalized with a thin layer of Zinc (Zn). The following key points have made this design suitable to IEC/UL testing, holding a minimum size.

- Overvoltage AC capability with very high temperature Endurance test of IEC60384-14 (4th edition) / UL60384-14 (2nd edition) must be performed at 1.25 × V_R at maximum temperature, during 1000 hours, with a capacitance drift less than 10%.
- Higher breakdown voltage withstanding if compared to other film metallizations, like Aluminum. IEC60384-14 (4th edition) / UL60384-14 (2nd edition) establishes high voltage tests performed at 4.3 × V_R −1 minute, impulse testing at 2500 V for C= 1 µF and active flammability tests.
- Damp heat steady state: 40 °C/ 93% RH / 56 days. (without voltage or current load)

Effect of humidity on capacitance stability

Long contact of a film capacitor with humidity can produce irreversible effects. Direct contact with liquid water or excess exposure to high ambient humidity or dew will eventually remove the film metallization and thus destroy the capacitor. Plastic boxed capacitors must be properly tested in the final application at the worst expected conditions of temperature and humidity in order to check if any parameter drift may provoke a circuit malfunction.

In case of penetration of humidity through the film, the layer of Zinc can be degraded, specially under AC operation (change of polarity), accelerated by the temperature, provoking an increment of the serial resistance of the electrode and eventually a reduction of the capacitance value. For DC operation, the parameter drift is much less.

Plastic boxes and resins can not protect 100% against humidity. Metal enclosures, resin potting or coatings or similar measures by customers in their applications will offer additional protection against humidity penetration.

Display of ordering codes for EPCOS products

The ordering code for one and the same product can be represented differently in data sheets, data books, other publications and the website of EPCOS, or in order-related documents such as shipping notes, order confirmations and product labels. **The varying representations of the ordering codes are due to different processes employed and do not affect the specifications of the respective products**. Detailed information can be found on the Internet under <u>www.epcos.com/orderingcodes</u>.



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X2

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α _c	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
β _c	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
С	Capacitance	Kapazität
C _R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
∆C/C	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
∆tan δ	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V / \Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f ₁	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f ₂	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f _r	Resonant frequency	Resonanzfrequenz
F _D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F _τ	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
l _c	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)



X2

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X2/350 V AC

Symbol	English	German
I _{RMS}	(Sinusoidal) alternating current,	(Sinusförmiger) Wechselstrom
	root-mean-square value	
i _z	Capacitance drift	Inkonstanz der Kapazität
k _o	Pulse characteristic	Impulskennwert
Ls	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λο	Constant failure rate during useful	Konstante Ausfallrate in der
	service life	Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P _{diss}	Dissipated power	Abgegebene Verlustleistung
P _{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des
		Entladekreises
R _i	Internal resistance	Innenwiderstand
R _{ins}	Insulation resistance	Isolationswiderstand
R _P	Parallel resistance	Parallelwiderstand
Rs	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
Т	Temperature	Temperatur
τ	Time constant	Zeitkonstante
tan δ	Dissipation factor	Verlustfaktor
tan δ_D	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
tan δ _P	Parallel component of dissipation factor	Parallelanteil des Verlfustfaktors
tan δ_s	Series component of dissipation factor	Serienanteil des Verlustfaktors
T _A	Temperature of the air surrounding the component	Temperatur der Luft, die das Bauteil umgibt
T _{max}	Upper category temperature	Obere Kategorietemperatur
T _{min}	Lower category temperature	Untere Kategorietemperatur
t _{oL}	Operating life at operating temperature	Betriebszeit bei Betriebstemperatur und
	and voltage	-spannung
T _{op}	Operating temperature	Beriebstemperatur
T _R	Rated temperature	Nenntemperatur
T _{ref}	Reference temperature	Referenztemperatur
t _{SL}	Reference service life	Referenz-Lebensdauer



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Symbol	English	German
V _{AC}	AC voltage	Wechselspannung
V _c	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige)
		Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
Vi	Input voltage	Eingangsspannung
Vo	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V _p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_{R}	Rated voltage	Nennspannung
ν _R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage,	(Sinusförmige) Wechselspannung
	root-mean-square value	
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung
		"Beschaltung"
Z	Impedance	Scheinwiderstand
е	Lead spacing	Rastermaß



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